SPECIFICATIONS

CUSTOMER .

SAMPLE CODE · SH720128T004-ZBC02

MASS PRODUCTION CODE . PH720128T004-ZBC02

SAMPLE VERSION . 02

SPECIFICATIONS EDITION . 005

DRAWING NO. (Ver.) . LMD-PH720128T004-ZBC02 (Ver.003)

PACKAGING NO. (Ver.) . PKG-PH720128T004-ZBC02 (Ver.001)

Customer Approved

Date:

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☐ Preliminary specification for design input

Specification for sample approval

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History of Version

Date (mm / dd / yyyy)	Ver.	Edi.	Description	Page	Design by
06/08/2017	01	001	New Drawing.	-	Yuan
07/28/2017	01	002	First Sample Add Shielding tape	- Appendix	Yuan
12/28/2017	02	003	Second Sample Modify Reliability Test Condition Modify Frame T/P FPC with EMI Shield	- 33 Appendix Appendix	Yuan
12/12/2018	02	004	Modify Contrast ratio	6	Yuan
08/16/2019	02	005	Modify LCD type from IPS to Full Viewing Angle ADD Refer Initial Code	4 21~31	Yuan

Total: 45 Page



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1. SPECIFICATIONS

1.1 Features

Item	Standard Value
Display Type	720 * (RGB) * 1280
LCD Type	Full Viewing Angle, Normally Black, Transmissive type
Touch panel	True Multi-Touch Capacitive Touch Panel True Multi-touch with up to 10 Points of Absolution
Screen size(inch)	5.0 inch
Backlight Type	LED B/L
Weight	95g
Control IC	ILI9881C
Interface	MIPI Interface
ROHS	THIS PRODUCT CONFORMS THE ROHS OF PTC Detail information please refer website: http://www.powertip.com.tw/news_detail.php?Key=1&cID=1

1.2 Mechanical Specifications

Item	Standard Value	
Outline Dimension	91.46 (W) * 143.4 (L) * 5.17 (H)	
Viewing Area	63.1 (W) * 111.4 (L)	
Active Area	62.1 (W) * 110.4 (L)	mm

Note: For detailed information please refer to LCM drawing



1.3 Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit	Remark
Supply Voltage	VDD	GND=0	-0.3	+3.8	V	
Supply Voltage	VCI	GND=0	-0.3	+7.0	V	
Operating Temperature	Top	-	-20	+70	°C	-
Storage Temperature	T _{ST}	-	-30	+80	°C	

1.4 DC Electrical Characteristics

GND = 0V, Ta = 25 ℃

Item	Symbol	Min.	Тур.	Max.	Unit	Remark
Supply Voltage	VDD	3.0	3.3	3.6		
Supply Voltage	VCI	3.0	3.3	3.6		
	V _{IH}	0.7*VDD		VDD	V	
Input signal Voltage	VıL	-0.3	-	0.3*VDD	V	-
(I2C Interface)	Vон	0.8*VDD	ı	VDD		
(2 33 332)	V _{OL}	0	-	0.2*VDD		
Supply Current	Ivdd	-	20	35	mA	Note1
Зарріу Сапені	Ivci	-	35	50	mA	Noter

Note1: Maximum current display.



1.5 Optical Characteristics

VDD =VCI= 3.3 V, Ta=25 ℃

				I	I	ı		
Item		Symbol	Condition	Min.	Тур.	Max.	unit	
Response tim	е	Tr +Tf	Ta = 25 °C θ X, θ Y = 0 °	-	35	40	ms	Note 2
	Тор	θΥ+		80	85	ŀ		
Viewing angle	Bottom	θΥ-	CR ≥ 10	80	85	ı	Dog	Note 4
viewing angle	Left	θX-	CR ≥ 10	80	85	-	Deg.	NOIE 4
	Right	θΧ+		80	85	-		
Contrast ratio)	CR		650	800	-		Note 3
	White	Х		0.26	0.31	0.36		
	vviile	Υ		0.31	0.36	0.41		
Color of CIE	Red	X	Ta = 25℃ θX,θY = 0°	0.61	0.66	0.71		Note1
Coordinate	nea	Υ		0.27	0.32	0.37		
(With B/L & touch	Green	X	3 71, 3 1 = 3	0.27	0.32	0.37	-	Note
panel)	Green	Υ		0.57	0.62	0.67		
	Blue	X X		0.09	0.14	0.19		
	Diue	Υ		0.01	0.04	0.09		
Average Brightn	ess							
Pattern=white dis	play	IV		430	500	_	cd/m ²	Note1
(With B/L & touch panel) *1			IF=40mA	400	300		OG/III	140101
Uniformity								
(With B/L & touch page	anel) *2	∆B		70	-	-	%	Note1



Note 1:

*1: \(\triangle B = B(min) / B(max) * 100%

*2 : Measurement Condition for Optical Characteristics:

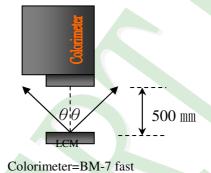
a: Environment: 25°C±5°C / 60±20%R.H, no wind, dark room below 10 Lux at typical lamp current and typical operating frequency.

b : Measurement Distance: 500 \pm 50 mm \rightarrow (θ = 0°)

c: Equipment: TOPCON BM-7 fast, (field 1°), after 10 minutes operation.

d: The uncertainty of the C.I.E coordinate measurement ±0.01, Average Brightness ± 4%





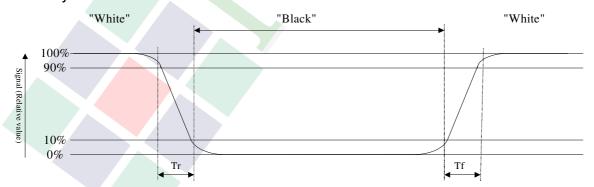
To be measured at the center area of panel with a viewing cone of 1° by Topcon luminance meter BM-7, after 10 minutes operation (module)

Note2: Definition of response time:

The output signals of photo detector are measured when the input signals are changed from "black" to "white" (falling time) and from "white" to "black" (rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes.

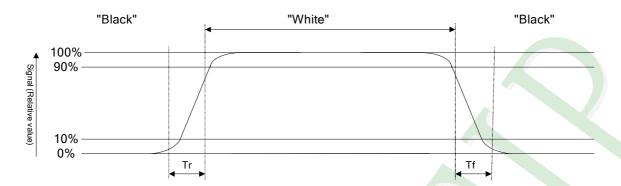
Refer to figure as below:

Normally White





Normally Black



Note3: Definition of contrast ratio:

Contrast ratio is calculated with the following formula

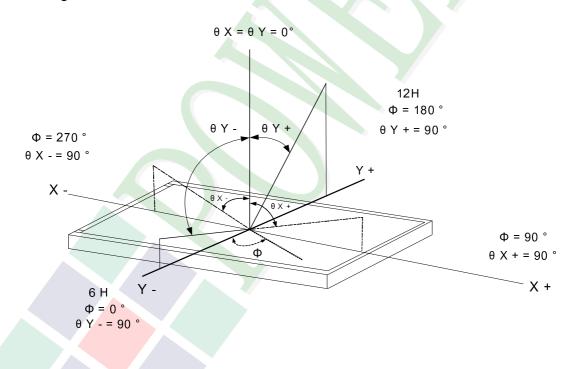
Photo detector output when LCD is at "White" state

Contrast ratio (CR) =

Photo detector output when LCD is at "Black" state

Note4: Definition of viewing angle:

Refer to figure as below:





1.6 Backlight Characteristics

Maximum Ratings

Item	Symbol	Conditions	Min.	Max.	Unit
LED Forward Current	IF	Ta =25°C	-	60	mA
LED Reverse Voltage	VR	Ta =25°℃	-	5	V
Power Dissipation	PD	Ta =25°℃	-	1120	W

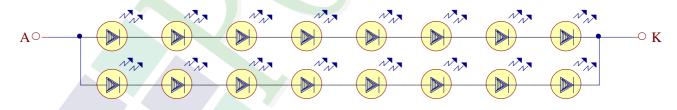
Backlight Characteristics

Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage	VF		21.6	24.8	28.0	V
Average Brightness (Without LCD)	IV	IF= 40 mA	12000	14500	16500	cd/m ²
CIE Color Coordinate	X	IF= 40 IIIA	0.27	0.30	0.33	
(Without LCD)	Υ		0.27	0.30	0.33	i
Uniformity *1	∆В		80	-	-	*2
Color			White			

*1 : This value will be changed while mass production.

*2 : △B=B(min) / B(max)%

B/L Internal Circuit Diagram



Other Description

Item	Conditions	Description
Life Time	Ta =25°C IF=40 mA	20000 hrs



1.7 Touch Panel Characteristics

Features

Item	Standard Value
Touch Panel Size	7"
Touch type	Projective capacitive touch panel
Input Method	True Multi-touch with up to 10 Points of Absolution X and Y Coordinates
Output Interface	I ² C
IC	FT5426

Mechanical Specifications

Item	Standard Value	Unit
Viewing Area	111.4 (W) * 63.1 (L)	mm
Number of sensing channel	22 x 12	mm

Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit
Supply voltage	TPVDD	-	-0.3	3.6	V
Operating Temperature	Top	-	-20	+70	∞
Storage Temperature	Tst	-	-30	+80	.€

DC Electrical Characteristics

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Power Supply Voltage	TPVDD	-	3.0	3.3	3.6	V
Input High Voltage	VIH	-	0.7 TPVDD	-	TPVDD	٧
Input Low Voltage	VIL	-	-0.3	-	0.3 TPVDD	٧
Output High Voltage	VOH	IOH=-0.1mA	0.7 TPVDD	-	-	٧
Output Low Voltage	VOL	IOL=+0.1mA	-	-	0.3 TPVDD	V



I²C Read/Write Interface description

Write N bytes to I2C slave

		S	Sla	ve .	Ado	lr				Ι	Dat	a A	dc	lres	s[2	[]					I	Dat	a [2	X]					Ι	Dat	a [2	X+]	N-1]			
S	A 6	A 5	A 4	A 3	A 2	A 1	A 0	R W	A	R 7	R 6	R 5	R 4	R 3	R 2	R 1	R	A	D 7	D 6	D 5	D 4	D 3	D 2	D 1	D 0	A	 D 7	D 6	D 5	D 4	D 3	D 2	D 1	D 0	A	P
START							•	WRITE	ACK	•			<u>.</u>			_		ACK	,							•	ACK								•	ACK	STOP

Set Data Address

		5	Slav	ve 1	4d	dr]	Dat	ta A	١da	lres	ss[2	K]			
C	A	A	A	Α	A	A	A	R	A	R	R	R	R	R	R	R	R	Λ	D
3	6	5	4	3	2	1	0	W	A	7	6	5	4	3	2	1	0	A	Г
S								4											7.0
STAR								\geq	AC									AC	STO
RT								TE	$\overline{\mathbf{x}}$									\nearrow	P

Read X bytes from I2C Slave

		5	Slav	ve 1	Ado	dr						Ι	Dat	a []	N]					1	Dat	a [X+	N-1	[]			
S	A 6	A 5	A 4	A 3	A 2	A 1	A 0	R W	A	D 7	D 6	D 5	D 4	D 3	D 2	D 1	D 0	A	 D 7					D 2	D 1	D 0	A	P
START					_	_		Read	ACK						_	_		ACK	•					_	_		ACK	STOP

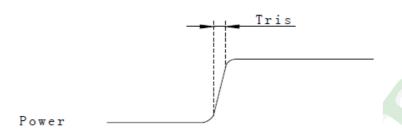
Mnemonics Description

Mnemonics	Description
S	I2C Start or I2C Restart
A[6:0]	Slave address
	A[6:0]:0111000b
R/W	'1' for read, '0' for write
A(N)	ACK(NACK)
P	STOP: the indication of the end of a packet (if this bit is missing, S will
	indicate the end of the current packet and the beginning of the next packet)

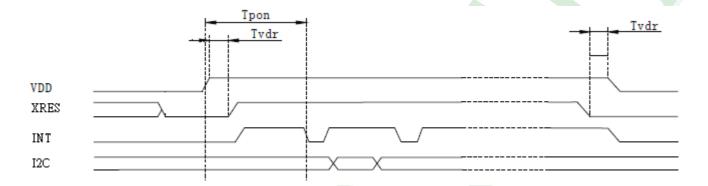
Timing Characteristics

Parameter	Unit	Min	Max
SCL frequency	KHz	0	400
Bus free time between a STOP and START condition	us	4.7	\
Hold time (repeated) START condition	us	4.0	\
Data setup time	ns	250	\
Setup time for a repeated START condition	us	4.7	\
Setup Time for STOP condition	us	4.0	\

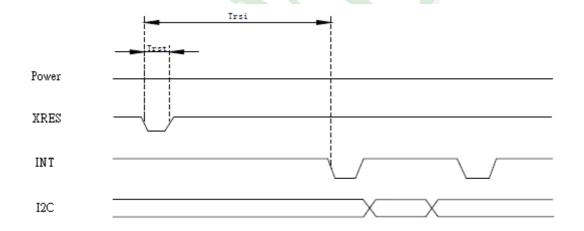




Power on time



Power on Sequence



Reset Sequence

Power on / Reset Sequence Parameters

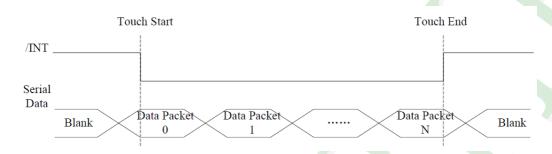
Parameter	Description	Min	Max	Units
Tris	Rise time from 0.1VDD to 0.9VDD		5	ms
Tpon	Time of starting to report point after powering on	200		ms
Tvdr	Reset time after VDD powering on	1		ms
Trsi	Time of starting to report point after resetting	200		ms
Trst	Reset time	1		ms



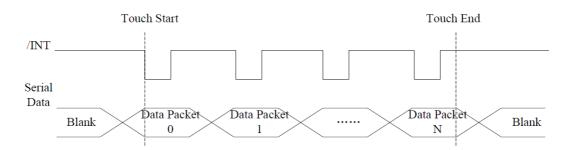
Interrupt signal from CTP to Host

As for standard CTP, host need to use both interrupt control signal and serial data interface to get the touch data. There are two kind of method to use interrupt: interrupt trigger and interrupt query.

Here is the timing to get touch data.



Interrupt query mode



Interrupt trigger mode

Host use general I2C protocol to read the touch data or the information from CTP . CTP will send host a interrupt signal when there is a valid touch. Then host can use the serial data interface to get the touch data. If there is no valid touch detected, the /INT will not be pulled up, the host do not need to read the touch data.

NOTE: "valid touch" may have different definition in various systems. For example, in some systems, the valid touch is defined as there is one more valid touch point. But in some other systems, the valid touch is defined as one more valid touch with valid gestures. In usual, /INT will be pulled up when there is a valid touch point, and to be low when a touch finishes.

As for interrupt trigger mode, /INT signal will be low if there is a touch detected. But for per update of valid touch data, CTP will produce a valid pulse for /INT signal, host can read the touch data periodically according to the frequency of this pulse. In this mode, the pulse frequency is the touch data update frequency.



CTP Register Mapping

										Host	
Address	Name	Bit7 Bit6 Bit5 Bit4 Bit3 Bit2 Bit1 Bit0									
00h	DEVIDE_MODE	-	Devid	ce Mode	[2:0]	-	-	-	7-	WR	
01h	GEST_ID			(Gesture I	D[7:0]				R	
02h	TD_STATUS	-	-	-	-	Numl	per of to	uch poin	ts[3:0]	R	
03h	TOUCH1_XH	1st Eve	nt Flag	-	-	1st T	ouch X	Position	[11:8]	R	
04h	TOUCH1_XL			1st To	ouch X P	osition[7	7:0]			R	
05h	TOUCH1_YH	1	st Touch	ID[3:0]	4	1st T	Couch Y	Position	[11:8]	R	
06h	TOUCH1_YL			1st To	ouch Y P	osition[7	7:0]			R	
07h	-				_					R	
08h	-				-					R	
09h	TOUCH2_XH	2st Ever	nt Flag	-	-	2st T	ouch X	Position	[11:8]	R	
0Ah	TOUCH2_XL			2st To	ouch X P	osition[7	7:0]			R	
0Bh	TOUCH2_YH	2	st Touch	ID[3:0]		2st T	ouch Y	Position	[11:8]	R	
0Ch	TOUCH2_YL			2st To	ouch Y P	osition[7	7:0]			R	
0Dh	-		-								
0Eh	-										
0Fh	TOUCH3_XH	3st Ever	3st Event Flag - 3st Touch X Position[11:8]								
10h	TOUCH3_XL			3st To	ouch X P	osition[7	7:0]			R	
11h	TOUCH3_YH	3	st Touch	ID[3:0]		3st T	ouch Y	Position	[11:8]	R	
12h	TOUCH3_YL			3st To	ouch Y P	osition[7	7:0]			R	
13h	-				-					R	
14h	-				-					R	
15h	TOUCH4_XH	4st Ever	nt Flag	-	-	4st T	ouch X	Position	[11:8]	R	
16h	TOUCH4_XL			4st To	ouch X P	osition[7	7:0]			R	
17h	TOUCH4_YH	4	st Touch	ID[3:0]		4st T	ouch Y	Position	[11:8]	R	
18h	TOUCH4_YL	4st Touch Y Position[7:0]								R	
19h	-				-					R	
1Ah	-				_					R	
1Bh	TOUCH5_XH	5st Ever	nt Flag	-		5st T	ouch X	Position	[11:8]	R	
1Ch	TOUCH5_XL			5st To	ouch X P	osition[7	7:0]			R	
1Dh	TOUCH5_YH	5	st Touch	ID[3:0]		5st T	ouch Y	Position	[11:8]	R	
1Eh	TOUCH5_YL			5st To	ouch Y P	osition[7	7:0]			R	
1Fh	-				-					R	
20h	-	-								R	



Address	Name	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	Host Access	
21h	TOUCH6_XH	6st Ev	ent Flag	-	-	6st	Touch X	Position	[11:8]	R	
22h	TOUCH6_XL			6st	Touch X	Position[[7:0]			R	
23h	TOUCH6_YH		6st Touc	h ID[3:0]	6st	Touch Y	Position	[11:8]	R	
24h	TOUCH6_YL			6st	Touch Y	Position[[7:0]			R	
25h	-				-	-				R	
26h	-				-					R	
27h	TOUCH7_XH	7st Eve	ent Flag	_	_	7st	Touch X	Position	[11:8]	R	
28h	TOUCH7_XL			7st 7	Touch X	Position[7:0]			R	
29h	TOUCH7_YH		7st Touc	h ID[3:0]	7st	Touch Y	Position[[11:8]	R	
2ah	TOUCH7_YL			7st	Touch Y	Position[[7:0]			R	
2bh	-									R	
2ch	-					V				R	
2dh	TOUCH8_XH	8st Eve	ent Flag	(-	-	8st	Touch X	Position	[11:8]	R	
2eh	TOUCH8_XL		8st Touch X Position[7:0]								
2fh	TOUCH8_YH		8st Touc	h ID[3:0		8st	Touch Y	Position[[11:8]	R	
30h	TOUCH8_YL			8st	Touch Y	Position[7:0]			R	
31h	-					-				R	
32h	-					-				R	
33h	TOUCH9_XH	9st Eve	ent Flag	-	-	9st	Touch X	Position	[11:8]	R	
34h	TOUCH9_XL			9st	Touch X	Position[[7:0]			R	
35h	TOUCH9_YH		9st Touc	h ID[3:0]	9st	Touch Y	Position[[11:8]	R	
36h	TOUCH9_YL			9st'	Touch Y	Position[[7:0]			R	
37h	-				-	-				R	
38h	-				-	-				R	
39h	TOUCH10_XH	10st Ev	ent Flag	-	_	10st	Touch X	X Position	n[11:8]	R	
3ah	TOUCH10_XL			10st	Touch X	Position	[7:0]			R	
3bh	TOUCH10_YH		10st Touc	ch ID[3:0)]	10st	Touch Y	Position	[11:8]	R	
3ch	TOUCH10_YL			10st	Touch Y	Position	[7:0]			R	
3dh			,		-	-				R	
3eh	-					-				R	
3fh	-					-				R	



DEVICE_MODE

This register is the device mode register, configure it to determine the current mode of the chip.

Address	Bit Address	Register Name	Description
001	6.1	Davias Mada [2:0]	000b Work Mode
00h	6:4	Device Mode [2:0]	100b Factory Mode – read raw data

GEST_ID

This register describes the gesture of a valid touch.

Address	Bit Address	Register Name	Description
01h	7:0	Gesture ID [7:0]	0x10 Move UP 0x14 Move Left 0x18 Move Down 0x1C Move Right 0x48 Zoom In 0x49 Zoom Out

TD_STATUS

This register is the Touch Data status register.

Address	Bit Address	Register Name	Description
	7:4	Reserved	
02h	3:0	Number of touch points[3:0]	How many points detected. 1-5 is valid.

TOUCHn_XH

This register describes MSB of the X coordinate of the nth touch point and the corresponding event flag.

Address	Bit Address	Register Name	Description
			00b: Put Down
021- 201-	7:6	Event Flog	01b: Put Up
		Event Flag	10b: Contact
03h ~ 39h			11b: Reserved
	5:4		Reserved
	3:0	Touch X Position [11:8]	MSB of Touch X Position in pixels

TOUCHn_XL

This register describes LSB of the X coordinate of the nth touch point

Address	Bit Address	Register Name	Description		
04h ~ 3Ah	7:0	Touch X Position [7:0]	LSB of the Touch X Position in pixels		



TOUCHn_YH

This register describes MSB of the Y coordinate of the nth touch point and corresponding touch ID.

	1	-	
Address Bit Address Registe		Register Name	Description
05h ~ 3Bh	7:4	Touch ID[3:0]	Touch ID of Touch Point
	3:0	Touch Y Position [11:8]	MSB of Touch Y Position in pixels

TOUCHn_YL

This register describes LSB of the Y coordinate of the nth touch point.

		1	
Address	Bit Address	Register Name	Description
06h ~ 3Ch	7:0	Touch Y Position[7:0]	LSB of The Touch Y Position in pixels



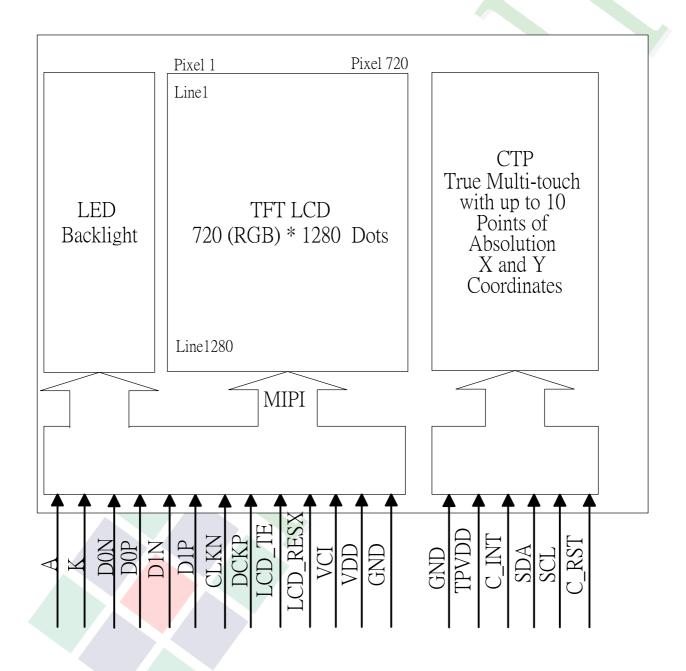
2. MODULE STRUCTURE

2.1 Counter Drawing

2.1.1 LCM Mechanical Diagram

* See Appendix

2.1.2 Block Diagram





2.2 Interface Pin Description

LCM interface

Pin#	Name	DESCRIPTION
1	NC	No Connection
2	K	Power Supply for LED Backlight cathode input
3	А	Power Supply for LED Backlight anode input
4	NC	No Connection
5	NC	No Connection
6	GND	Ground.
7	NC	No Connection
8	NC	No Connection
9	VDD	Power Supply for internal logic regulator.
10	VCI	Power Supply for analog circuit
11	GND	Ground.
12	LCD_RESX	The external reset pin.
13	LCD_TE	Tearing effect output pin .
14	GND	Ground.
15	CLKP	MIPI Differential Clock Pair.
16	CLKN	MIPI Differential Clock Pair.
17	GND	Ground.
18	D1P	MIPI Differential Data Pair. (Data Lane 1)
19	D1N	MIPI Differential Data Pair. (Data Lane 1)
20	GND	Ground.
21	D0P	MIPI Differential Data Pair. (Data Lane 0)
22	D0N	MIPI Differential Data Pair. (Data Lane 0)
23	GND	Ground.
24	NC	No Connection



Capacitive Touch Panel (CTP) Interface

Pin No.	Symbol	Function
1	C_RST	RESET.
2	SCL	I ² C Clock.
3	SDA	I ² C Data.
4	C_INT	The interrupt from the CTP to the Host H: CTP interrupt not requested L: CTP request interrupt
5	TPVDD	Power.
6	GND	Ground.



2.3 **Refer Initial Code:** //****** Reset LCD Driver *********// LCD nRESET = 1; Delayms(1); // Delay 1ms LCD nRESET = 0;Delayms(1); // Delay 1ms // This Delay time is necessary LCD nRESET = 1; Delayms(10); // Delay 120 ms //************ Start Initial Sequence ********// LCD_ILI9881C_CMD(0xFF); LCD_ILI9881C_INDEX(0x98); LCD_ILI9881C_INDEX(0x81); LCD_ILI9881C_INDEX(0x03); LCD ILI9881C CMD(0x01); LCD_ILI9881C_INDEX(0x00); LCD_ILI9881C_CMD(0x02); LCD_ILI9881C_INDEX(0x00); LCD ILI9881C CMD(0x03); LCD_ILI9881C_INDEX(0x73); LCD ILI9881C CMD(0x04); LCD ILI9881C INDEX(0x73); LCD_ILI9881C_CMD(0x05); LCD_ILI9881C_INDEX(0x00); LCD_ILI9881C_CMD(0x06); LCD ILI9881C INDEX(0x06); LCD ILI9881C CMD(0x07); LCD_ILI9881C_INDEX(0x02); LCD_ILI9881C_CMD(0x08); LCD ILI9881C INDEX(0x00); LCD_ILI9881C_CMD(0x09); LCD ILI9881C INDEX(0x01); LCD_ILI9881C_CMD(0x0a); LCD_ILI9881C_INDEX(0x01); LCD ILI9881C CMD(0x0b); LCD_ILI9881C_INDEX(0x01); LCD ILI9881C CMD(0x0c); LCD_ILI9881C_INDEX(0x01); LCD_ILI9881C_CMD(0x0d); LCD_ILI9881C_INDEX(0x01); LCD ILI9881C CMD(0x0e);

LCD_ILI9881C_INDEX(0x01);



```
LCD_ILI9881C_CMD(0x0f);
LCD ILI9881C INDEX(0x01);
LCD_ILI9881C_CMD(0x10);
LCD_ILI9881C_INDEX(0x01);
LCD ILI9881C CMD(0x11);
LCD_ILI9881C_INDEX(0x00);
LCD ILI9881C CMD(0x12);
LCD_ILI9881C_INDEX(0x00);
LCD_ILI9881C_CMD(0x13);
LCD_ILI9881C_INDEX(0x01);
LCD_ILI9881C_CMD(0x14);
LCD_ILI9881C_INDEX(0x00);
LCD_ILI9881C_CMD(0x15);
LCD_ILI9881C_INDEX(0x00);
LCD ILI9881C CMD(0x16);
LCD_ILI9881C_INDEX(0x00);
LCD_ILI9881C_CMD(0x17);
LCD ILI9881C INDEX(0x00);
LCD_ILI9881C_CMD(0x18);
LCD_ILI9881C_INDEX(0x00);
LCD_ILI9881C_CMD(0x19);
LCD ILI9881C INDEX(0x00);
LCD ILI9881C CMD(0x1a);
LCD_ILI9881C_INDEX(0x00);
LCD_ILI9881C_CMD(0x1b);
LCD ILI9881C INDEX(0x00);
LCD_ILI9881C_CMD(0x1c);
LCD_ILI9881C_INDEX(0x00);
LCD_ILI9881C_CMD(0x1d);
LCD_ILI9881C_INDEX(0x00);
LCD ILI9881C CMD(0x1e);
LCD_ILI9881C_INDEX(0xC0);
LCD_ILI9881C_CMD(0x1f);
LCD_ILI9881C_INDEX(0x80);
LCD_ILI9881C_CMD(0x20);
LCD_ILI9881C_INDEX(0x04);
```



```
LCD ILI9881C CMD(0x21);
LCD_ILI9881C_INDEX(0x03);
LCD_ILI9881C_CMD(0x22);
LCD_ILI9881C_INDEX(0x00);
LCD ILI9881C CMD(0x23);
LCD_ILI9881C_INDEX(0x00);
LCD_ILI9881C_CMD(0x24);
LCD_ILI9881C_INDEX(0x00);
LCD_ILI9881C_CMD(0x25);
LCD_ILI9881C_INDEX(0x00);
LCD_ILI9881C_CMD(0x26);
LCD_ILI9881C_INDEX(0x00);
LCD ILI9881C CMD(0x27);
LCD ILI9881C INDEX(0x00);
LCD_ILI9881C_CMD(0x28);
LCD_ILI9881C_INDEX(0x33);
LCD_ILI9881C_CMD(0x29);
LCD_ILI9881C_INDEX(0x03);
LCD_ILI9881C_CMD(0x2a);
LCD_ILI9881C_INDEX(0x00);
LCD ILI9881C CMD(0x2b);
LCD_ILI9881C_INDEX(0x00);
LCD_ILI9881C_CMD(0x2c);
LCD ILI9881C INDEX(0x00);
LCD_ILI9881C_CMD(0x2d);
LCD_ILI9881C_INDEX(0x00);
LCD ILI9881C CMD(0x2e);
LCD_ILI9881C_INDEX(0x00);
LCD ILI9881C CMD(0x2f);
LCD_ILI9881C_INDEX(0x00);
LCD_ILI9881C_CMD(0x30);
LCD_ILI9881C_INDEX(0x00);
LCD ILI9881C CMD(0x31);
LCD_ILI9881C_INDEX(0x00);
LCD_ILI9881C_CMD(0x32);
LCD ILI9881C INDEX(0x00);
LCD_ILI9881C_CMD(0x33);
```



```
LCD_ILI9881C_INDEX(0x00);
LCD ILI9881C CMD(0x34);
LCD_ILI9881C_INDEX(0x03);
LCD_ILI9881C_CMD(0x35);
LCD ILI9881C INDEX(0x00);
LCD_ILI9881C_CMD(0x36);
LCD_ILI9881C_INDEX(0x03);
LCD_ILI9881C_CMD(0x37);
LCD_ILI9881C_INDEX(0x00);
LCD ILI9881C CMD(0x38);
LCD_ILI9881C_INDEX(0x00);
LCD_ILI9881C_CMD(0x39);
LCD_ILI9881C_INDEX(0x00);
LCD_ILI9881C_CMD(0x3a);
LCD_ILI9881C_INDEX(0x00);
LCD_ILI9881C_CMD(0x3b);
LCD_ILI9881C_INDEX(0x00);
LCD ILI9881C CMD(0x3c);
LCD_ILI9881C_INDEX(0x00);
LCD_ILI9881C_CMD(0x3d);
LCD_ILI9881C_INDEX(0x00);
LCD ILI9881C CMD(0x3e);
LCD_ILI9881C_INDEX(0x00);
LCD_ILI9881C_CMD(0x3f);
LCD_ILI9881C_INDEX(0x00);
LCD ILI9881C CMD(0x40);
LCD_ILI9881C_INDEX(0x00);
LCD ILI9881C CMD(0x41);
LCD_ILI9881C_INDEX(0x00);
LCD_ILI9881C_CMD(0x42);
LCD_ILI9881C_INDEX(0x00);
LCD ILI9881C CMD(0x43);
LCD_ILI9881C_INDEX(0x00);
LCD ILI9881C CMD(0x44);
LCD_ILI9881C_INDEX(0x00);
LCD_ILI9881C_CMD(0x50);
LCD_ILI9881C_INDEX(0x01);
```



```
LCD ILI9881C CMD(0x51);
LCD_ILI9881C_INDEX(0x23);
LCD_ILI9881C_CMD(0x52);
LCD_ILI9881C_INDEX(0x45);
LCD ILI9881C CMD(0x53);
LCD_ILI9881C_INDEX(0x67);
LCD_ILI9881C_CMD(0x54);
LCD_ILI9881C_INDEX(0x89);
LCD_ILI9881C_CMD(0x55);
LCD_ILI9881C_INDEX(0xab);
LCD_ILI9881C_CMD(0x56);
LCD_ILI9881C_INDEX(0x01);
LCD ILI9881C CMD(0x57);
LCD ILI9881C INDEX(0x23);
LCD_ILI9881C_CMD(0x58);
LCD_ILI9881C_INDEX(0x45);
LCD_ILI9881C_CMD(0x59);
LCD_ILI9881C_INDEX(0x67);
LCD_ILI9881C_CMD(0x5a);
LCD_ILI9881C_INDEX(0x89);
LCD ILI9881C CMD(0x5b);
LCD_ILI9881C_INDEX(0xab);
LCD_ILI9881C_CMD(0x5c);
LCD ILI9881C INDEX(0xcd);
LCD_ILI9881C_CMD(0x5d);
LCD_ILI9881C_INDEX(0xef);
LCD ILI9881C CMD(0x5e);
LCD_ILI9881C_INDEX(0x10);
LCD ILI9881C CMD(0x5f);
LCD_ILI9881C_INDEX(0x09);
LCD_ILI9881C_CMD(0x60);
LCD_ILI9881C_INDEX(0x08);
LCD ILI9881C CMD(0x61);
LCD_ILI9881C_INDEX(0x0F);
LCD_ILI9881C_CMD(0x62);
LCD_ILI9881C_INDEX(0x0E);
LCD_ILI9881C_CMD(0x63);
```



```
LCD_ILI9881C_INDEX(0x0D);
LCD ILI9881C CMD(0x64);
LCD_ILI9881C_INDEX(0x0C);
LCD_ILI9881C_CMD(0x65);
LCD ILI9881C INDEX(0x02);
LCD_ILI9881C_CMD(0x66);
LCD_ILI9881C_INDEX(0x02);
LCD_ILI9881C_CMD(0x67);
LCD_ILI9881C_INDEX(0x02);
LCD ILI9881C CMD(0x68);
LCD_ILI9881C_INDEX(0x02);
LCD_ILI9881C_CMD(0x69);
LCD_ILI9881C_INDEX(0x02);
LCD_ILI9881C_CMD(0x6a);
LCD_ILI9881C_INDEX(0x02);
LCD_ILI9881C_CMD(0x6b);
LCD_ILI9881C_INDEX(0x02);
LCD ILI9881C CMD(0x6c);
LCD_ILI9881C_INDEX(0x02);
LCD_ILI9881C_CMD(0x6d);
LCD_ILI9881C_INDEX(0x02);
LCD ILI9881C CMD(0x6e);
LCD_ILI9881C_INDEX(0x02);
LCD_ILI9881C_CMD(0x6f);
LCD_ILI9881C_INDEX(0x02);
LCD ILI9881C CMD(0x70);
LCD_ILI9881C_INDEX(0x02);
LCD_ILI9881C_CMD(0x71);
LCD_ILI9881C_INDEX(0x06);
LCD_ILI9881C_CMD(0x72);
LCD_ILI9881C_INDEX(0x07);
LCD ILI9881C CMD(0x73);
LCD_ILI9881C_INDEX(0x02);
LCD ILI9881C CMD(0x74);
LCD_ILI9881C_INDEX(0x02);
LCD_ILI9881C_CMD(0x75);
LCD_ILI9881C_INDEX(0x06);
```



```
LCD_ILI9881C_CMD(0x76);
LCD ILI9881C INDEX(0x07);
LCD_ILI9881C_CMD(0x77);
LCD_ILI9881C_INDEX(0x0E);
LCD ILI9881C CMD(0x78);
LCD_ILI9881C_INDEX(0x0F);
LCD ILI9881C CMD(0x79);
LCD_ILI9881C_INDEX(0x0C);
LCD_ILI9881C_CMD(0x7a);
LCD_ILI9881C_INDEX(0x0D);
LCD_ILI9881C_CMD(0x7b);
LCD_ILI9881C_INDEX(0x02);
LCD_ILI9881C_CMD(0x7c);
LCD_ILI9881C_INDEX(0x02);
LCD ILI9881C CMD(0x7d);
LCD_ILI9881C_INDEX(0x02);
LCD_ILI9881C_CMD(0x7e);
LCD ILI9881C INDEX(0x02);
LCD_ILI9881C_CMD(0x7f);
LCD_ILI9881C_INDEX(0x02);
LCD_ILI9881C_CMD(0x80);
LCD ILI9881C INDEX(0x02);
LCD ILI9881C CMD(0x81);
LCD_ILI9881C_INDEX(0x02);
LCD_ILI9881C_CMD(0x82);
LCD ILI9881C INDEX(0x02);
LCD_ILI9881C_CMD(0x83);
LCD_ILI9881C_INDEX(0x02);
LCD_ILI9881C_CMD(0x84);
LCD_ILI9881C_INDEX(0x02);
LCD ILI9881C CMD(0x85):
LCD_ILI9881C_INDEX(0x02);
LCD_ILI9881C_CMD(0x86);
LCD_ILI9881C_INDEX(0x02);
LCD_ILI9881C_CMD(0x87);
LCD_ILI9881C_INDEX(0x09);
```



```
LCD ILI9881C CMD(0x88);
LCD_ILI9881C_INDEX(0x08);
LCD ILI9881C CMD(0x89);
LCD_ILI9881C_INDEX(0x02);
LCD ILI9881C CMD(0x8A);
LCD_ILI9881C_INDEX(0x02);
LCD_ILI9881C_CMD(0xFF);
LCD ILI9881C INDEX(0x98);
LCD_ILI9881C_INDEX(0x81);
LCD ILI9881C INDEX(0x04);
LCD ILI9881C CMD(0x6C);
LCD_ILI9881C_INDEX(0x15);
LCD_ILI9881C_CMD(0x6E);
LCD_ILI9881C_INDEX(0x2A);
LCD_ILI9881C_CMD(0x6F);
LCD_ILI9881C_INDEX(0x57);
LCD_ILI9881C_CMD(0x3A);
LCD_ILI9881C_INDEX(0xA4);
LCD ILI9881C CMD(0x8D);
LCD_ILI9881C_INDEX(0x1A);
LCD_ILI9881C_CMD(0x87);
LCD_ILI9881C_INDEX(0xBA);
LCD ILI9881C CMD(0x26);
LCD_ILI9881C_INDEX(0x76);
LCD_ILI9881C_CMD(0xB2);
LCD_ILI9881C_INDEX(0xD1);
LCD ILI9881C CMD(0xFF);
LCD ILI9881C INDEX(0x98);
LCD_ILI9881C_INDEX(0x81);
LCD_ILI9881C_INDEX(0x01);
LCD_ILI9881C_CMD(0x22);
LCD ILI9881C INDEX(0x0A);
LCD ILI9881C CMD(0x31):
LCD_ILI9881C_INDEX(0x00);
LCD_ILI9881C_CMD(0x53);
LCD_ILI9881C_INDEX(0x35);
LCD_ILI9881C_CMD(0x55);
LCD_ILI9881C_INDEX(0x50);
```



```
LCD ILI9881C CMD(0x50);
LCD_ILI9881C_INDEX(0xAF);
LCD_ILI9881C_CMD(0x51);
LCD_ILI9881C_INDEX(0xAF);
LCD ILI9881C CMD(0x60);
LCD_ILI9881C_INDEX(0x14);
LCD_ILI9881C_CMD(0xA0);
LCD_ILI9881C_INDEX(0x08);
LCD_ILI9881C_CMD(0xA1);
LCD_ILI9881C_INDEX(0x1D);
LCD_ILI9881C_CMD(0xA2);
LCD_ILI9881C_INDEX(0x2C);
LCD ILI9881C CMD(0xA3);
LCD ILI9881C INDEX(0x14);
LCD_ILI9881C_CMD(0xA4);
LCD_ILI9881C_INDEX(0x19);
LCD_ILI9881C_CMD(0xA5);
LCD_ILI9881C_INDEX(0x2E);
LCD_ILI9881C_CMD(0xA6);
LCD_ILI9881C_INDEX(0x22);
LCD ILI9881C CMD(0xA7);
LCD_ILI9881C_INDEX(0x23);
LCD_ILI9881C_CMD(0xA8);
LCD ILI9881C INDEX(0x97);
LCD_ILI9881C_CMD(0xA9);
LCD_ILI9881C_INDEX(0x1E);
LCD ILI9881C CMD(0xAA);
LCD_ILI9881C_INDEX(0x29);
LCD ILI9881C CMD(0xAB);
LCD_ILI9881C_INDEX(0x7B);
LCD_ILI9881C_CMD(0xAC);
LCD_ILI9881C_INDEX(0x18);
LCD ILI9881C CMD(0xAD);
LCD_ILI9881C_INDEX(0x17);
LCD_ILI9881C_CMD(0xAE);
LCD_ILI9881C_INDEX(0x4B);
LCD_ILI9881C_CMD(0xAF);
```



```
LCD_ILI9881C_INDEX(0x1F);
LCD ILI9881C CMD(0xB0);
LCD_ILI9881C_INDEX(0x27);
LCD_ILI9881C_CMD(0xB1);
LCD ILI9881C INDEX(0x52);
LCD_ILI9881C_CMD(0xB2);
LCD_ILI9881C_INDEX(0x63);
LCD_ILI9881C_CMD(0xB3);
LCD_ILI9881C_INDEX(0x39);
LCD ILI9881C CMD(0xC0);
LCD_ILI9881C_INDEX(0x08);
LCD_ILI9881C_CMD(0xC1);
LCD_ILI9881C_INDEX(0x1D);
LCD_ILI9881C_CMD(0xC2);
LCD_ILI9881C_INDEX(0x2C);
LCD_ILI9881C_CMD(0xC3);
LCD_ILI9881C_INDEX(0x14);
LCD ILI9881C CMD(0xC4);
LCD_ILI9881C_INDEX(0x19);
LCD_ILI9881C_CMD(0xC5);
LCD_ILI9881C_INDEX(0x2E);
LCD ILI9881C CMD(0xC6);
LCD_ILI9881C_INDEX(0x22);
LCD_ILI9881C_CMD(0xC7);
LCD_ILI9881C_INDEX(0x23);
LCD ILI9881C CMD(0xC8);
LCD_ILI9881C_INDEX(0x97);
LCD ILI9881C CMD(0xC9);
LCD_ILI9881C_INDEX(0x1E);
LCD_ILI9881C_CMD(0xCA);
LCD_ILI9881C_INDEX(0x29);
LCD ILI9881C CMD(0xCB);
LCD_ILI9881C_INDEX(0x7B);
LCD ILI9881C CMD(0xCC);
LCD_ILI9881C_INDEX(0x18);
LCD_ILI9881C_CMD(0xCD);
LCD_ILI9881C_INDEX(0x17);
```

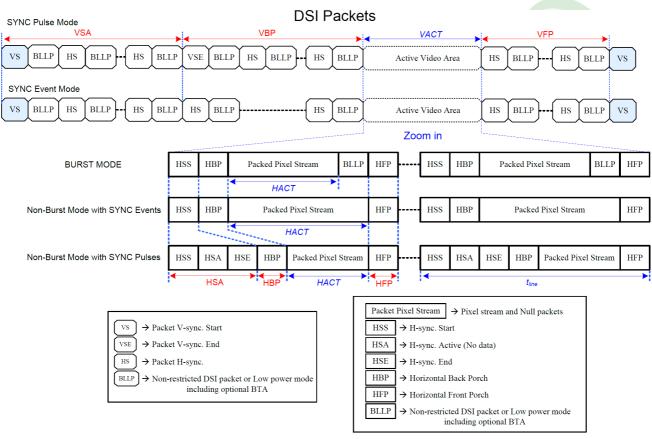


```
LCD_ILI9881C_CMD(0xCE);
LCD ILI9881C INDEX(0x4B);
LCD_ILI9881C_CMD(0xCF);
LCD_ILI9881C_INDEX(0x1F);
LCD ILI9881C CMD(0xD0);
LCD_ILI9881C_INDEX(0x27);
LCD ILI9881C CMD(0xD1);
LCD_ILI9881C_INDEX(0x52);
LCD_ILI9881C_CMD(0xD2);
LCD_ILI9881C_INDEX(0x63);
LCD_ILI9881C_CMD(0xD3);
LCD_ILI9881C_INDEX(0x39);
LCD_ILI9881C_CMD(0xFF);
LCD_ILI9881C_INDEX(0x98);
LCD_ILI9881C_INDEX(0x81);
LCD_ILI9881C_INDEX(0x00);
LCD_ILI9881C_CMD(0x35);
Void ILI9881C EnterSleep Code(Void)
LCD ILI9881C CMD(0x28) //Display oFF
Delayms(20);
LCD_ILI9881C_CMD(0x10); // Internal oscillator will be stopped
Delayms(120);
Void ILI9881C ExitSleep Code(Void)
LCD_ILI9881C_CMD(0x11); // Sleep Out
Delayms(120);
LCD_ILI9881C_CMD(0x29) //Display on
Delayms(20);
```



2.3 AC Electrical Characteristics

2.3.1 Timing for DSI video mode



Parameters	Symbols	Min.	Тур.	Max.	Units
Vertical sync. active	VSA	2 (Note 6)	-	-	Line
Vertical Back Porch	VBP	14 (Note 6)	-	-	Line
Vertical Front Porch	VFP	8 (Note 6)	-	-	Line
Active lines per frame	VACT	-	1280	-	Line
Horizontal sync. active	HSA	2	-	-	Pixel
Horizontal Porch period	HSA + HBP + HFP	1.6	-	-	us
Active pixels per line	HACT	-	720	-	Pixel
Bit rate	BR _{bps}	385		Note 5	Mbps/lane

1 UI=1/Bit rate

HSA(pixel)= (tHSA*lane number) / (UI* pixel format)

HBP(pixel)= (tHBP*lane number) / (UI* pixel format)

HFP(pixel)= (tHFP*lane number) / (UI* pixel format)

$$Frame\ Rate = \frac{BR_{bps}\ x\ Lane_{num}}{(VACT+VSA+VBP+VFP)\ x\ (HACT+HSA+HBP+HFP)\ x\ Pixel\ Format}$$

Example : $BR_{bps} = 457 Mbps/lane$, 1UI=2.1883 ns, Frame rate=60Hz, VACT=1280, VSA=2, VBP=30, VFP=20, HACT=720, HSA=33, HBP=100, HFP=100, Lane_{num}=4(lane), Pixel Format=24(bit).



Note:

- 1. Lane_{num}: Date lane of MIPI-DSI.
- 2. Pixel Format: Please reference to "4.1DSI System Interface".
- 3. The formula exists slightly error because of the host-transmission way.
- 4. The best frame rate setting : $2 \text{ data lanes} : 50\sim60 \text{ Hz}/ 3 \text{ data lanes} : 50\sim70 \text{ Hz}/ 4 \text{ data lanes} : 50\sim70 \text{ Hz}.$
- 5. Please reference to "Table 39: Limited Clock Channel Speed".
- 6. The minimum values of this table mean the limitation of IC without considering the panel GIP. The actual values of VSA, VBP and VFP will be changed by different panel GIP setting.





2.3.2 Reset Timing

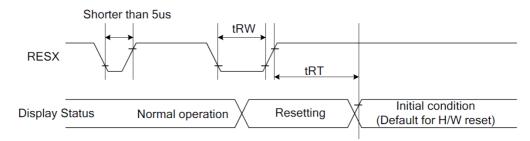


Figure 124: Reset Timing

Table 47: Reset Timing

Signal	Symbol	Parameter	Min	Max	Unit
tRW		Reset pulse duration 10			uS
RESX	LDT.			5 (note 1,5)	mS
	tRT Reset cancel			120 (note 1,6,7)	mS

Notes:

- 1. The reset cancel also includes required time for loading ID bytes, VCOM setting and other settings from EEPROM to registers. This loading is done every time when there is H/W reset cancel time (tRT) within 5 ms after a rising edge of RESX.
- 2. Spike due to an electrostatic discharge on RESX line does not cause irregular system reset according to the Table 48.

Table 48: Reset Descript

RESX Pulse	Action
Shorter than 5us	Reset Rejected
Longer than 10us	Reset
Between 5us and 10us	Reset starts

- 3. During the Resetting period, the display will be blanked (The display enters the blanking sequence, which maximum time is 120 ms, when Reset Starts in the Sleep Out mode. The display remains the blank state in the Sleep In mode.) and then return to Default condition for Hardware Reset.
- 4. Spike Rejection can also be applied during a valid reset pulse, as shown below:

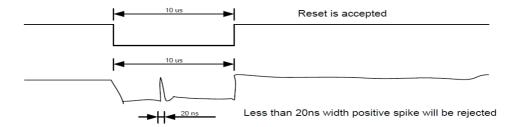


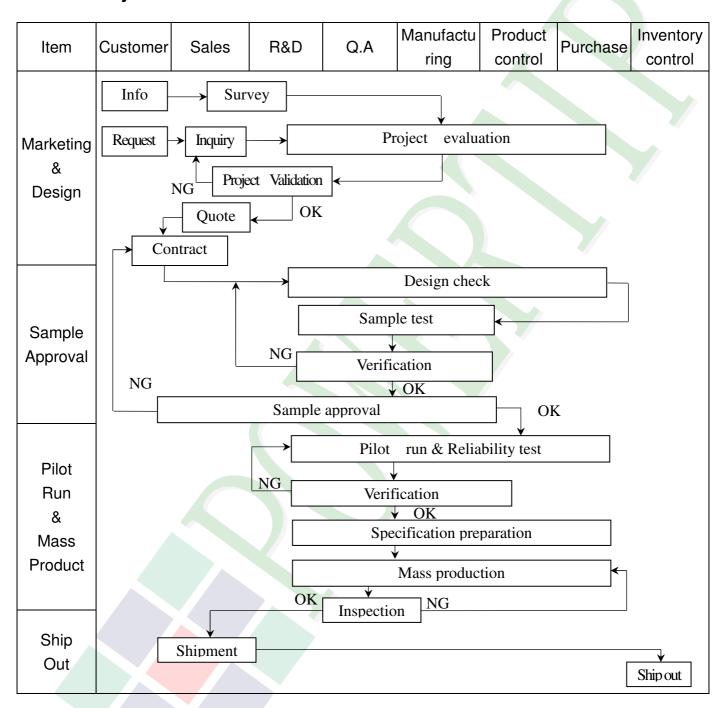
Figure 125: Positive Noise Pulse during Reset Low

- 5. When Reset applied during Sleep In Mode.
- 6. When Reset applied during Sleep Out Mode.
- 7. It is necessary to wait 5msec after releasing RESX before sending commands. Also Sleep Out command cannot be sent for 120msec.

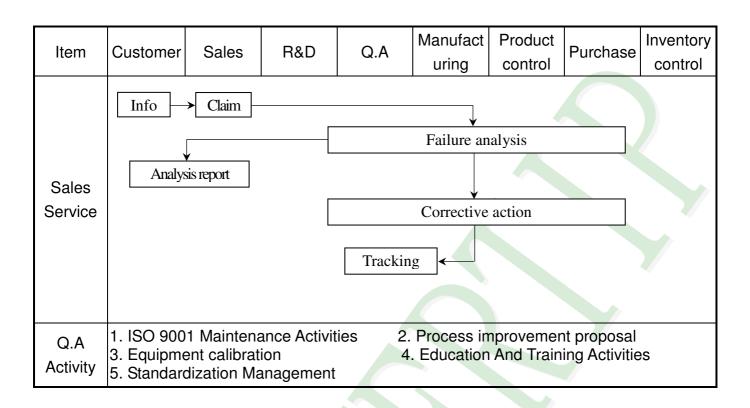


3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart









3.2. Inspection Specification

◆Scope: The document shall be applied to TFT-LCD Module for 3. 5" ~15" (Ver.B01).

◆Inspection Standard: MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.

◆Equipment : Gauge · MIL-STD · Powertip Tester · Sample

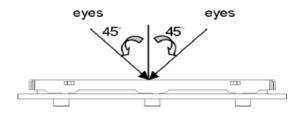
◆Defect Level: Major Defect AQL: 0.4; Minor Defect AQL: 1.5

♦OUT Going Defect Level: Sampling.

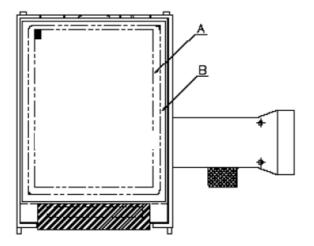
◆Standard of the product appearance test:

a. Manner of appearance test:

- (1). The test best be under 20W×2 fluorescent light, and distance of view must be at 30 cm.
- (2). The test direction is base on about around 45° of vertical line.



(3). Definition of area.



A area: viewing area

B area: Outside of viewing area

(4). Standard of inspection: (Unit: mm)



◆Specification For TFT-LCD Module 3. 5" ~15":

Spec	Cilication For TF 1-L	CD Modu	Wiodule 3, 3 ~13 ·					
NO	Item			Criteri	on	Level		
		1. 1The part number is inconsistent with work order of production.						
01	Product condition	1. 2 Mix	1. 2 Mixed product types.					
		1. 3 Asse	embled i	n inverse direction.		Major		
02	Quantity	2. 1The	quantity	is inconsistent with	n work order of production.	Major		
03	Outline dimension	-	duct din gram.	nension and struct	ure must conform to structure	Major		
		4. 1 Missing line character and icon.						
		4. 2 No 1	function	or no display.		Major		
04	Electrical Testing	4. 3 Display malfunction.						
		4. 4 LCD viewing angle defect.						
		4. 5 Current consumption exceeds product specifications.						
		4. 6 Mura can not be seen through 5% ND filter. (Mura: Under the normal examination angle of view,the picture has the non-uniform phenomenon.)						
				Item	Acceptance (Q'ty)			
				Bright Dot	≤ 4			
	Dot defect		Dot	Dark Dot	≦ 5			
			Defect	Joint Dot	≦ 3			
05	(Bright dot \ Dark dot)			Total	≦ 7	Minor		
	On -display	5.1 Inspection pattern: full white, full black, Red, Green and						
		blue screens.						
				as dot defect if defe				
				between two dot d	erect ≥5 mm. seen through 5% ND filter.			
		J. 4 DI 1	giit uot	that can not be	Seen unough J/ NV IIIter.			



◆Specification For TFT-LCD Module 3. 5" ~15":

<u> </u>		-LCD Module 3, 5 ~15 · Criterion								
NO	Item				Crit	erion			Level	
06	Black or white dot \ scratch \ contamination Round type → X	6. 2 Lin	Dimensio	Non-displation (diameter $\Phi \le 0$. $< \Phi \le 0$. $< \Phi > 0$. Total on-display of Length (L) $= L \le 10.0$ L ≤ 5.0 $= L \le 10.0$	r: Ф) 25 50 0.50 or displ W 0.03 0.05	Acceptant A area Ignore 5 0 5 ay):	Acceptance A area Ignore 4 2 As round type 5 Ignore 5 As round type 5 5 S S S S S S S S S S S S S S S S S		Minor	
		Ι	Dimension	(diameter :	Φ) –	Accepta A area	nce (Q'ty) B are	ea		
				$\Phi \le 0.25$;	Ignore				
07	Polarizer Bubble		0.25 <	$\Phi \le 0.50$		4				
	Dassic		0.50 <	$\Phi \le 0.80$		1	Ignore			
				$\Phi > 0.80$	0	0				
			T	Total		5				



◆Specification For TFT-LCD Module 3. 5" ~15":

NO	Item	Criterion	Level
08	The crack of glass	Symbols: X: The length of crack Z: The thickness of crack t: The thickness of glass 8. 1 General glass chip: 8. 1. 1 Chip on panel surface and crack between panels: SP Y ING ING Seal width X Y: The width of crack. W: terminal length a: LCD side length ING ING ING ING ING ING ING IN	Minor
		X Y Z	
		\leq a Crack can't enter viewing area \leq 1/2 t	
		\leq a Crack can't exceed the half of SP width. 1/2 t < Z \leq 2 t	



◆Specification For TFT-LCD Module 3.5″~15″:

	X Z t t 8.	Z: The thic : The thic : 1. 2 Corne	gth of crack ckness of crack kness of glass er crack:	Y: The w W: termin a: LCD s		
			Y		\mathbf{z}	
		≦1/5 a	Crack can't enter viewing area	z	≤ 1/2 t	
		≦1/5 a	Crack can't exceed the half of SP width.	ne 1/2 t <	< Z ≤ 2 t	
08 The cra		8.2 Protrusion over terminal: 8.2.1 Chip on electrode pad:			Minor	
) W	Z X Y Z				
			X	Y	Z	
		Front	≦ a ≤	1/2 W	≦ t	
		Back	≦ a ≦	≦ W	≤ 1/2 t	



◆Specification For TFT-LCD Module 3, 5" ~15":

NO	Item	Criterion	Level
08	The crack of glass	Symbols: X: The length of crack Z: The thickness of crack t: The thickness of glass a: LCD side length 8. 2. 2 Non-conductive portion: X Y Z Simple side side side side side side side sid	Minor



◆Specification For TFT-LCD Module 3. 5″~15″:

NO	Item	Criterion	Level
09	Backlight elements	9. 1 Backlight can't work normally.	Major
		9. 2 Backlight doesn't light or color is wrong.	Major
		9. 3 Illumination source flickers when lit.	Major
10	General appearance	10. 1 Pin type · quantity · dimension must match type in structure diagram.	Major
		10. 2 No short circuits in components on PCB or FPC .	Major
		10. 3 Parts on PCB or FPC must be the same as on the production characteristic chart .There should be no wrong parts , missing parts or excess parts.	Major
		10. 4 Product packaging must the same as specified on packaging specification sheet.	Minor
		10. 5 The folding and peeled off in polarizer are not acceptable.	Minor
		10. 6 The PCB or FPC between B/L assembled distance(PCB or FPC) is ≤1.5 mm.	Minor



4. RELIABILITY TEST

4.1 Reliability Test Condition

NO.	TEST ITEM	TEST CONDITION		
1	High Temperature Storage Test	Keep in +80 ±2℃ 240 hrs Surrounding temperature, then storage at normal condition 4hrs.		
2	Low Temperature Storage Test	Keep in −30 ±2°C 240 hrs Surrounding temperature, then storage at normal condition 4hrs.		
3	High Temperature / High Humidity Storage Test	Keep in +60°C / 90% R.H duration for 240 hrs Surrounding temperature, then storage at normal condition 4hrs. (Excluding the polarizer)		
4	Temperature Cycling Storage Test	$-30^{\circ} C \rightarrow +25^{\circ} C \rightarrow +80^{\circ} C \rightarrow +25^{\circ} C$ $(30 \text{mins}) (5 \text{mins}) (5 \text{mins})$ 10 Cycle Surrounding temperature, then storage at normal condition 4hrs.}		
5	ESD Test	Air Discharge: Apply 2 KV with 5 times Discharge for each polarity +/- 1. Temperature ambiance: $15^{\circ}\text{C} \sim 35^{\circ}\text{C}$ 2. Humidity relative: $30\% \sim 60\%$ 3. Energy Storage Capacitance(Cs+Cd): $150\text{pF}\pm10\%$ 4. Discharge Resistance(Rd): $330\Omega\pm10\%$ 5. Discharge, mode of operation: Single Discharge (time between successive discharges at least 1 sec) (Tolerance if the output voltage indication: $\pm5\%$)		
6	Vibration Test (Packaged)	 Sine wave 10~55 Hz frequency (1 min) The amplitude of vibration :1.5 mm Each direction (X \ Y \ Z) duration for 2 Hrs 		
7	Drop Test (Packaged)	Packing Weight (Kg) 0 ~ 45. 4 122 45. 4 ~ 90. 8 76 90. 8 ~ 454 61 Over 454 46 Drop direction: **1 corner / 3 edges / 6 sides each 1 times		



5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

5.2 HANDLING

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module, be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully ,do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is 320±10°C and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM.

5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is 25° C $\pm 5^{\circ}$ C and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

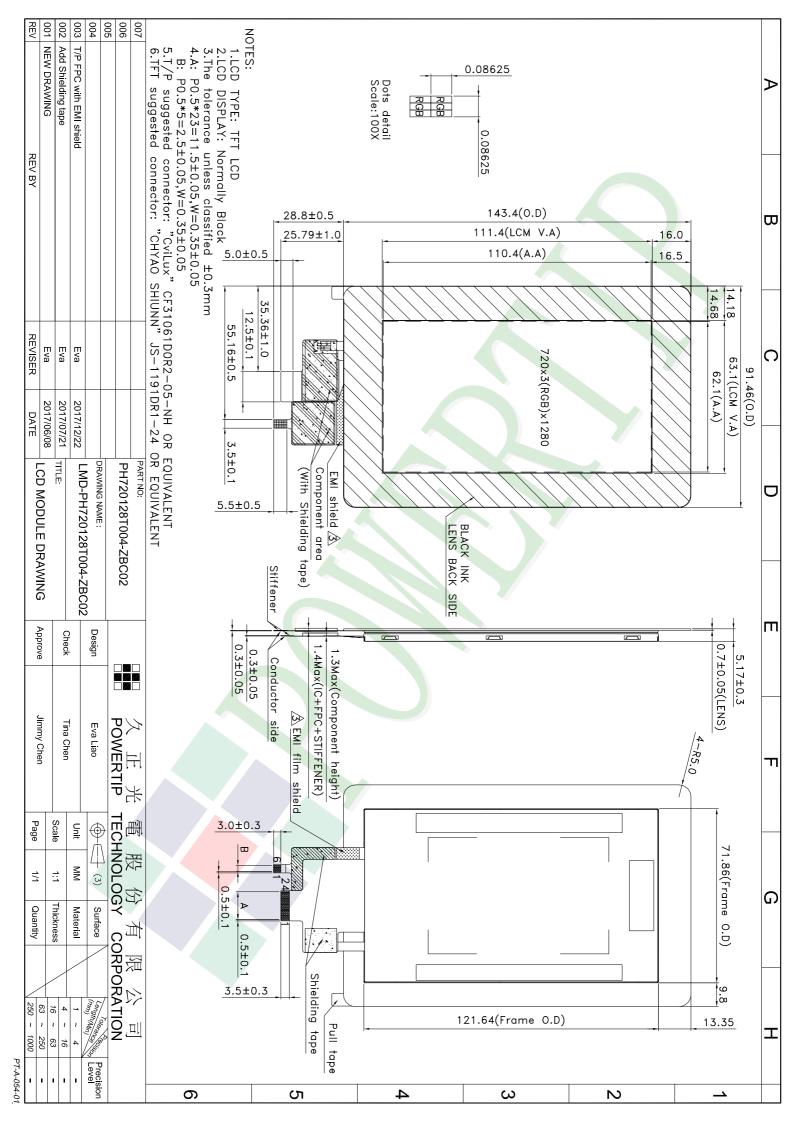
5.4 TERMS OF WARRANTY

5.4.1 Applicable warrant period

The period is within thirteen months since the date of shipping out under normal using and storage conditions.

5.4.2 Unaccepted responsibility

This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



Approve Check Contact Ver.001 LCM包裝規格書 LCM Packaging Specifications Documents NO. PKG-PH720128T004-ZBC02 Jimmy Tina Eva (For Tray) 1.包裝材料規格表 (Packaging Material): (per carton) 1Pcs Weight Total Weight Item Model Dimensions (mm) Quantity PH720128T004-ZBC02 成品 (LCM) 143.4X91.46X5.17 120 1 0.094 11.28 多層薄膜(1)POF 2 OTFILM0BA03ABA 19"X350X0.015 6 3 TRAY 盤 (2)Tray TYSG000000135 352 X 260 X 14.2 0.099 36 3.564 4 内盒(3)Product Box BX36627063ABBA 383 X 270 X 66 0.182 6 1.092 OTPLB00PL08ABA 0.0284 2 0.0568 5 保利龍板(4)Polylon board 550 X 393 X 20 570 X 410 X 265 6 外紙箱(5)Carton 1 BX57041027CCBA 1.0 1.0 7 8 9 一整箱總重量 (Total LCD Weight in carton): 16.99 Kg±10% 3.單箱數量規格表 (Packaging Specifications and Quantity): (1)LCM quantity per box : no per tray x no of tray 5 20 (2) Total LCM quantity in carton: quantity per box x no of boxes 20 120 6 (4)保利龍板 Use empty tray 空盤 Polylon board (1)多層薄膜 POF Put products into the tray (2)TRAY 盤 (4)保利龍板 Tray Polylon board ₩, (3)内盒 Tray stacking Product Box (5)外紙箱 Carton 特 記 事 項 (REMARK) 斜角 Detail B Trav 2 圓角 4.TRAY盤相疊時,需旋轉180度,請詳見B視圖 Rotate tray 180 degrees and place on top of stack. Check the tray stack using Fig. B.